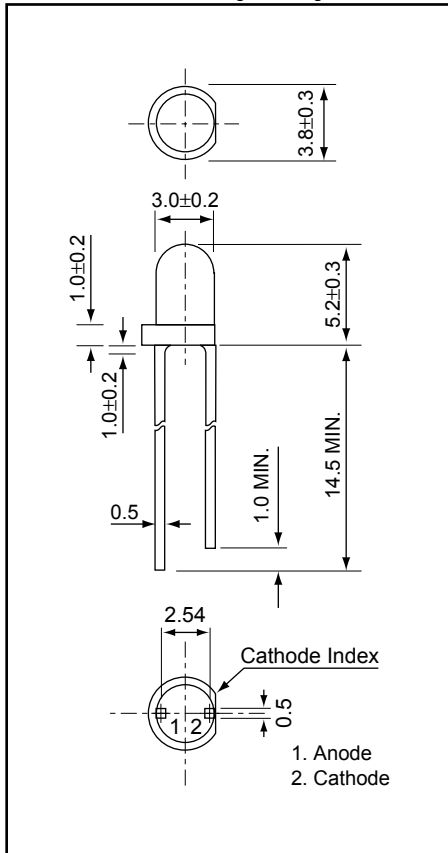




Weight: 0.12 g Unit: mm

\*RoHS compliant

\*EU REACH compliant



# AND160NG

## GaP Green Light Emission

### T-1 Package (3 mm)

#### Features

- Striking Bright
- Peak wavelength ( $\lambda_p = 570$  nm) high bright emission
- All plastic mold type, clear colorless lens
- Low drive current (15 to 20 mA)
- Excellent On-Off contrast ratio
- Fast response time, capable of pulse operation

#### Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Rating	Unit
Forward Current	$I_F$	30	mA
Reverse Voltage	$V_R$	5	V
Power Dissipation	$P_D$	100	mW
Operating Temperature Range	$T_{Opr}$	-40 to 85	$^\circ\text{C}$
Storage Temperature Range	$T_{Stg}$	-40 to 100	$^\circ\text{C}$

#### Electro-Optical Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	$V_F$	$I_F = 20$ mA	–	2.15	2.4	V
Reverse Current	$I_R$	$V_R = 4$ V	–	–	10	$\mu\text{A}$
Luminous Intensity	$I_V$	$I_F = 20$ mA	80	160	–	mcd
Peak Emission Wavelength	$\lambda_p$	$I_F = 20$ mA	–	570	–	nm
Spectral Line Half Width	$\Delta\lambda$	$I_F = 20$ mA	–	30	–	nm
Dominant Wavelength	$\lambda_d$	$I_F = 20$ mA	–	571	–	nm
Full Viewing Angle	$\theta$	$I_V = 1/2$ Peak	–	20	–	degree

#### Precaution

Please be careful of the following:

1. Soldering temperature:  $260^\circ\text{C}$  max  
Soldering time: 5 sec. max  
Soldering portion of lead: up to 1.6 mm from the body of the device
2. The lead can be formed up to 5 mm from the body of the device without forming stress.  
Soldering should be performed after the lead forming.

